

Product Change Notification

Change Notification #: 114258 - 00

Change Title: Intel® SSD DC S3710 Series

(200GB, 400GB, 800GB, 1.2TB, 2.5in SATA 6Gb/s, 20nm, MLC)

7mm, Generic 50 Pack

Intel® SSD DC S3710 Series (200GB, 400GB, 800GB, 1.2TB, 2.5in SATA 6Gb/s, 20nm, MLC)

7mm, Generic Single Pack Intel® SSD DC S3610 Series (200GB, 400GB, 800GB, 1.8in SATA 6Gb/s, 20nm, MLC) 7mm,

Generic 50 Pack

Intel® SSD DC S3610 Series (200GB, 400GB, 800GB, 1.8in SATA 6Gb/s, 20nm, MLC) 7mm,

Generic Single Pack

Intel® SSD DC S3610 Series (100GB, 200GB, 400GB, 480GB, 800GB, 1.2TB, 1.6TB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Generic 50 Pack

Intel® SSD DC S3610 Series (100GB, 200GB, 400GB, 480GB, 800GB, 1.2TB, 1.6TB, 2.5in SATA 6Gb/s, 20nm, MLC) 7mm, Generic

Single Pack

Intel® SSD DC S3510 Series (80GB, 120GB, 240GB, 480GB, 800GB, 1.2TB, 1.6TB, 2.5in SATA 6Gb/s, 16nm, MLC) 7mm, Generic Single Pack

Intel® SSD DC S3510 Series (80GB, 120GB, 240GB, 480GB, 800GB, 1.2TB, 1.6TB, 2.5in SATA 6Gb/s, 16nm, MLC) 7mm, Generic

50 Pack,

PCN 114258-00, Label, Australian Regulatory Label Update

Date of Publication: December 21, 2015

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*: Jan 4, 2016

Description of Change to the Customer:

The following label changes supporting the Australia Regulatory Mark Change:

The Australian Communications and Media Authority's (ACMA) labeling arrangements to reflect

- Regulatory compliance changed on 1 March 2013, to be phased in over a three-year transition period. Products shipping March 1, 2016 need to be labeled with the "RCM" mark.
- Per ACMA requirements, Intel will be changing the C-Tick regulatory mark on all products to the "RCM" mark, and will implement the change no later than Mar 1st, 2016.

See the following labels for details:

Intel® SSD DC S3710 Series – 2.5 in.

Current



^{*} Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible



SA: XXXXXXX-XXX PBA: XXXXXXX-XXX LBA XXX,XXX,XXX

Pb-free 2LI Model:

SSDSXXXXXXXXX

WWN: XXXXXXXXXXXXXXXX

WO: XXXXXXX FW: XXXXXXXX

> VDC AMPS +5V 1.4A

WO: XXXXXXX FW: XXXXXXXX

Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd.
Santa Clara, CA 95054-1549

Intel Corporation Attn: Corporate Quality 2200 Mission College Blvd. Santa Clara, CA 95054-1549

2.5" XGb/s SATA SSD XXXG

Disclaimer: WARRANTY VOID IF ANY LABEL/

SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in China.



CAN ICES-3(B)/NMB-3(B)

MSIP-REM-CPU-SSDSA2Y



Intel® SSD DC S3610 Series – 2.5 in.

Current

Intel® SSD DC SXXXX Series XXXGB



ISN: XXXXXXXXXXXXXXXXXX

SA: XXXXXXX-XXX PBA: XXXXXXX-XXX LBA XXX,XXX,XXX

Pb-free 2LI

CAN ICES-3(B)/NMB-3(B)

Model: SSDXXXXXXXXXX

2.5" XGb/s SATA SSD XXXG

Disclaimer: WARRANTY VOID IF ANY LABEL/

SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in China.



















WWN: XXXXXXXXXXXXXXXXX







New



ISN: XXXXXXXXXXXXXXXXXX

SA: XXXXXXX-XXX

PBA: XXXXXXX-XXX LBA XXX,XXX,XXX

Pb-free 2LI

Model: SSDSXXXXXXXXX

Disclaimer: WARRANTY VOID IF ANY LABEL/ SCREW IS REMOVED OR BROKEN

2.5" XGb/s SATA SSD XXXG

Designed in USA, assembled in China.



CAN ICES-3(B)/NMB-3(B)

MSIP-REM-CPU-SSDSA2Y



Intel® SSD DC S3610 Series – 1.8 in.

Current

Model:

Intel® SSD DC SXXXX Series XXXGB

SA: XXXXXX-XXX

Attn: Corporate Quality 2200 Mission College Blvd. Santa Clara, CA 95054-1549 PBA: XXXXXXX-XXX LBA XXX,XXX,XXX USA WO: XXXXXXX Pb-free 2LI

SSDXXXXXXXXXX 1.8" XGb/s SATA SSD XXXG 3.3V 1A

Disclaimer: WARRANTY VOID IF ANY LABEL/

SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in China.











FW: XXXXXXXX

Intel Corporation













VDC AMPS +5V 1.4A

WO: XXXXXXX FW: XXXXXXXX

Intel Corporation Attn: Corporate Quality 2200 Mission College Blvd. Santa Clara, CA 95054-1549

WWN: XXXXXXXXXXXXXXXX

New



FW: XXXXXXXX

SA: XXXXXXX-XXX PBA: XXXXXXX-XXX LBA XXX,XXX,XXX Pb-free 2LI

Intel Corporation Attn: Corporate Quality 2200 Mission College Blvd. Santa Clara, CA 95054-1549 WO: XXXXXXX

WWN: XXXXXXXXXXXXXXXX

Model: SSDXXXXXXXXXX

1.8" XGb/s SATA SSD XXXG 3.3V 1A

Disclaimer: WARRANTY VOID IF ANY LABEL/

SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in China.









CAN ICES-3(B)/NMB-3(B) MSIP-REM-CPU-SSDSA1Y









VDC

+5V

USA

WWN: XXXXXXXXXXXXXXXX

AMPS

2.0A

+5V/+12V 1.0A/0.5A

Intel Corporation Attn: Corporate Quality 2200 Mission College Blvd. Santa Clara, CA 95054-1549

WO: XXXXXXX FW: XXXXXXXX

Intel® SSD DC S3510 Series – 2.5 in.

Current

Intel® SSD DC SXXXX Series X.XTB



ISN: XXXXXXXXXXXXXXXXXXX

SA: XXXXXXX-XXX

PBA: XXXXXXX-XXX LBA XXX,XXX,XXX

Pb-free 2LI

CAN ICES-3(B)/NMB-3(B)

SSDXXXXXXXXXX Model:

2.5" XGb/s SATA SSD X.XT Disclaimer: WARRANTY VOID IF ANY LABEL/

SCREW IS REMOVED OR BROKEN

Designed in USA, assembled in China.











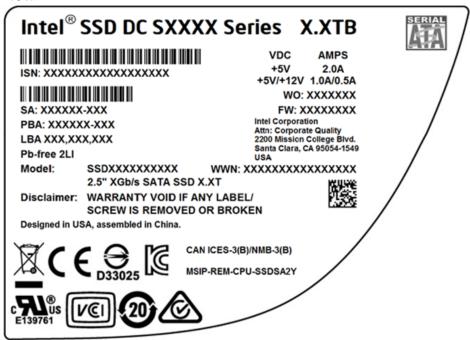








New



Customer Impact of Change and Recommended Action:

There is no change to the Form, Fit, or Function of the product. The change is only to the labels used in packaging.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

* Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Product Code	MM#
SSDSC2BA200G401	937741
SSDSC2BA200G4	937742
SSDSC2BA400G401	937743
SSDSC2BA400G4	937744
SSDSC2BA800G401	937745

SSDSC2BA800G4	937746
SSDSC2BA000G4 SSDSC2BA012T401	937747
SSDSC2BA012T401 SSDSC2BA012T4	937748
Product Code	MM#
SSDSC2BG480G401	
	937749
SSDSC2BG480G4	937750
SSDSC2BG800G401	937751
SSDSC2BG800G4	937752
SSDSC2BG012T401	937753
SSDSC2BG012T4	937755
SSDSC2BG016T401	937756
SSDSC2BG016T4	937757
SSDSC1BG200G401	939145
SSDSC1BG200G4	939146
SSDSC1BG400G401	939147
SSDSC1BG400G4	939148
SSDSC1BG800G401	939149
SSDSC1BG800G4	939150
SSDSC2BG200G401	940055
SSDSC2BG200G4	940056
SSDSC2BG400G401	940057
SSDSC2BG400G4	940058
SSDSC2BX200G4	940778
SSDSC2BX200G401	940779
SSDSC2BX400G4	940780
SSDSC2BX400G401	940781
SSDSC2BX480G4	940782
SSDSC2BX480G401	940783
SSDSC2BX800G4	940784
SSDSC2BX800G401	940785
SSDSC2BX012T4	940786
SSDSC2BX012T401	940788
SSDSC2BX016T4	940789
SSDSC2BX016T401	940790
SSDSC2BB080G601	941809
SSDSC2BB080G6	941810
SSDSC2BB120G601	941811
SSDSC2BB120G6	941812
SSDSC2BB240G601	941813
SSDSC2BB240G6	941814
SSDSC2BB480G601	941815
SSDSC2BB480G6	941816
SSDSC2BB800G601	941818
SSDSC2BB800G6	941819
SSDSC2BB012T601	941820
SSDSC2BB012T6	941821
SSDSC2BB012T6 SSDSC2BB016T601	941822
SSDSC2BB016T6	941823
SSDSC2BX100G401	942238
SSDSC2BX100G401	942239
DDDCZDATOUCT	/ 44437

PCN Revision History:

Date of Revision: Revision Number: Reason:

December 21, 2015 00 Originally Published PCN



Product Change Notification 114258 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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